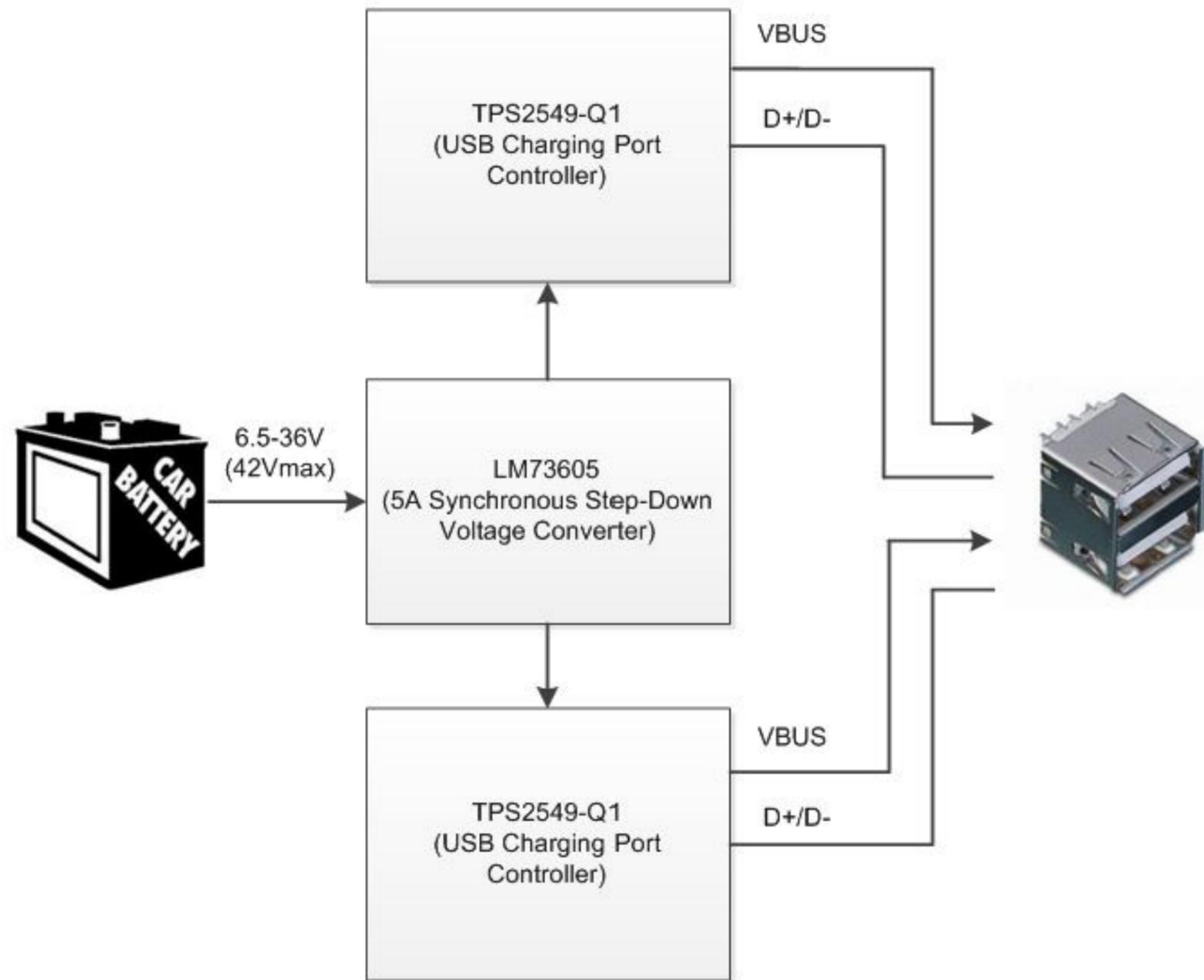
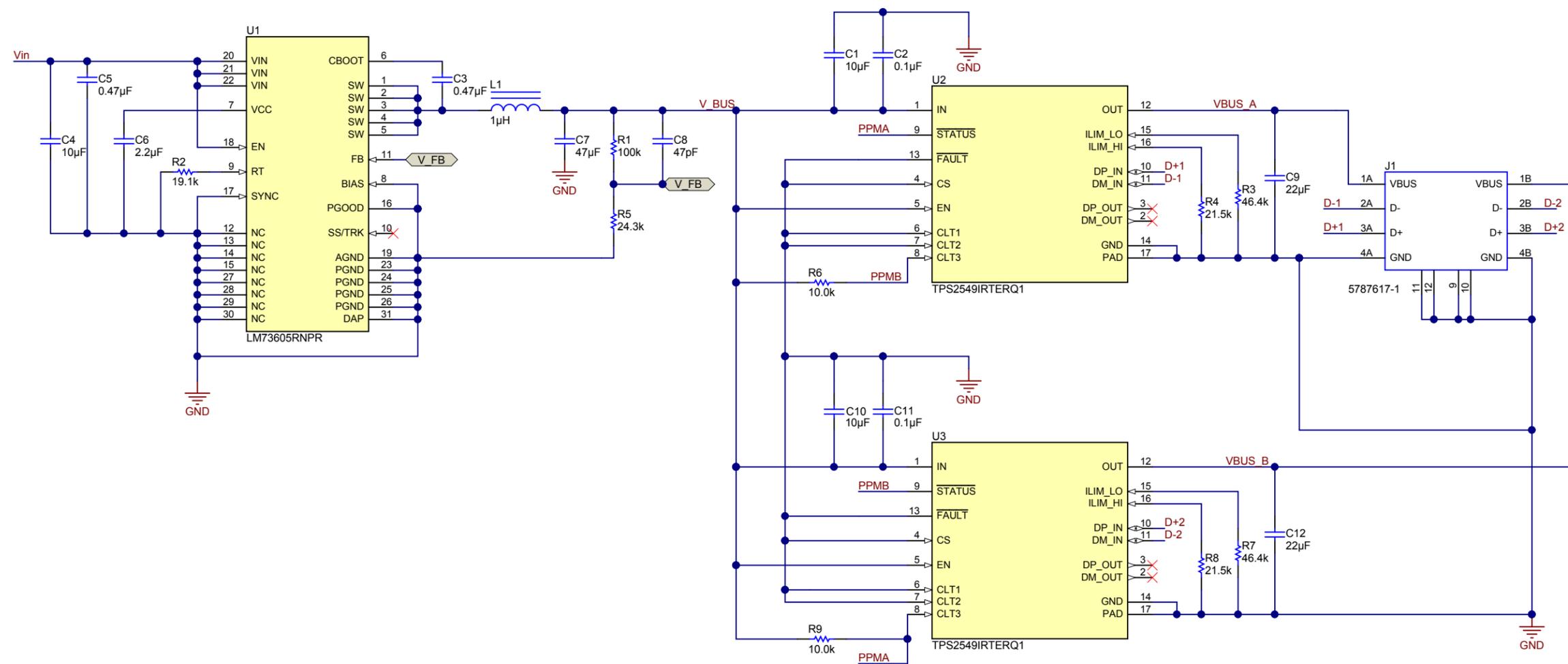


| Revision History | | | | |
|------------------|-------|---------------|-------------|-------|
| Rev | ECN # | Approved Date | Approved by | Notes |
| N/A | N/A | N/A | N/A | N/A |



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| Orderable: N/A | Designed for: Public Release | Mod. Date: 5/23/2016 | |
| TID #: PMP11670 | Project Title: Dual USB Car Charger with Port Power Management | Sheet: 1 of 2 | |
| Number: PMP11670 | Rev: 1.0 | Assembly Variant: 001 | Size: B |
| SVN Rev: Version control disabled | File: PMP11670_CoverSheet.SchDoc | Contact: http://www.ti.com/support | http://www.ti.com |
| Drawn By: Yingyang Ou | Engineer: Yingyang Ou | | © Texas Instruments 2016 |



ZZ2
Assembly Note
 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

PCB Number: PMP11670
 PCB Rev: 1.0

PCB
 LOGO
 Pb-Free Symbol

| | | | |
|-----------------------------------|--|----------------------|--|
| Orderable: N/A | Designed for: Public Release | Mod. Date: 5/19/2016 | TEXAS INSTRUMENTS http://www.ti.com © Texas Instruments 2016 |
| TID #: PMP11670 | Project Title: Dual USB Car Charger with Port Power Management | | |
| Number: PMP11670 | Rev: 1.0 | Sheet Title: | |
| SVN Rev: Version control disabled | Assembly Variant: 001 | | |
| Drawn By: | File: PMP11670_Main.SchDoc | Sheet: 2 of 2 | |
| Engineer: Yingyang Ou | Contact: http://www.ti.com/support | Size: B | |

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